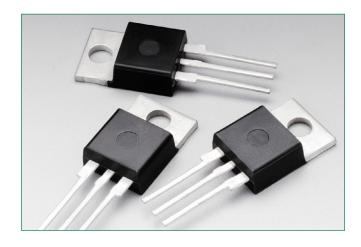
BTB12-600TW3G

Surface Mount - 600V





Description

The BTB12 is designed for high performance full-wave AC control applications where high noise immunity and high commutating di/dt are required.

Features

- Blocking Voltage to 600 V
- On-State Current Rating of 12 Amperes RMS at 80°C
- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to dV/dt 10 V/µs minimum at 125°C
- Minimizes Snubber Networks for Protection
- Industry Standard TO-220AB Package
- High Commutating dl/dt –
 1.75 A/ms minimum at 110°C
- These are Pb-Free Devices

Additional Information





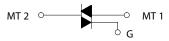


Resources

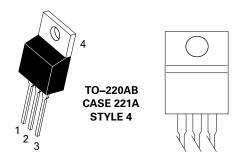
Accessories

Samples

Functional Diagram



Pin Out





BTB12-600TW3G

Surface Mount - 600V

Maximum Ratings (TJ = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit	
Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, $T_J = -40^{\circ}$ to 110°C)	BTB12-600BW3G	V _{DRM} , V _{RRM}	600	V
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, $T_c = 80$	0°C)	I _{T (RMS)}	12	Α
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T_c = 25°C)	I _{TSM}	126	А	
Circuit Fusing Consideration (t = 8.3 ms)	l²t	66	A ² sec	
Non-Repetitive Surge Peak Off-State Voltage (T, = 25°C, t = 10 ms)		V _{DSM} /V _{RSM}	V _{DSM} /V _{RSM} +100	V
Peak Gate Current ($T_J = 110^{\circ}$ C, $t = 20\mu$ s)	I _{GM}	4.0	W	
Peak Gate Power (Pulse Width \leq 1.0 μ s, T _C = 80°C)	P_{GM}	20	W	
Average Gate Power (T _j = 110°C)	$P_{G(AV)}$	1.0	W	
Operating Junction Temperature Range	T	-40 to +110	°C	
Storage Temperature Range	T _{stg}	-40 to +150	°C	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Thermal Characteristics

Rating		Symbol	Value	Unit
Thermal Resistance,	Junction-to-Case (AC) Junction-to-Ambient	R _{eJC} R _{eJA}	1.8 60	°C/W
Maximum Lead Temperature for Soldering Purpose	s, 1/8" from case for 10 seconds	T,	260	°C

Electrical Characteristics - OFF ($TJ = 25^{\circ}C$ unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Blocking Current	T ₁ = 25°C	I _{DRM} ,	-	-	0.005	A
$(V_D = V_{DRM} = V_{RRM}; Gate Open)$	T _J = 110°C	I _{BBM}	-	-	1.0	mA

Electrical Characteristics - ON $(TJ = 25^{\circ}C)$ unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Forward On-State Voltage (Note 2) $(I_{TM} = \pm 17 \text{ A Peak})$		V_{TM}	_	_	1.55	V
	MT2(+), G(+)		1.2	_	5.0	
Gate Trigger Current (Continuous dc) $(V_D = 12 \text{ V}, R_L = 30 \Omega)$	MT2(+), G(-)	l _{gt}	1.2	_	5.0	mA
	MT2(-), G(-)		1.2	_	5.0	
Holding Current ($V_D = 12 \text{ V}$, Gate Open, Initiating Current = $\pm 100 \text{ mA}$)		I _H	_	-	10	mA
	MT2(+), G(+)		_	_	15	
Latching Current ($V_D = 1.2 \text{ V}, I_G = 7.5 \text{ mA}$)	MT2(+), G(-)	l _L	_	_	15	mΑ
	MT2(-), G(-)		_	_	15	
	MT2(+), G(+)		0.5	_	1.3	
Gate Trigger Voltage ($V_D = 12 \text{ V}, R_L = 30 \Omega$)	MT2(+), G(-)	$V_{\rm GT}$	0.5	_	1.3	V
	MT2(-), G(-)		0.5	_	1.3	
	MT2(+), G(+)		0.2	_	_	
Gate Non-Trigger Voltage (T, = 110°C)	MT2(+), G(-)	V_{gD}	0.2	_	_	V
	MT2(-), G(-)		0.2	_	_	

2. Indicates Pulse Test: Pulse Width \leq 2.0 ms, Duty Cycle \leq 2%



^{1.} V_{DBM} and V_{SBM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

BTB12-600TW3G Surface Mount - 600V

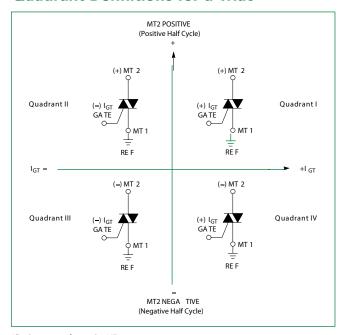
Dynamic Characteristics

Characteristic	Symbol	Min	Тур	Max	Unit
Rate of Change of Commutating Current, See Figure 10. (Gate Open, $T_J = 125^{\circ}\text{C}$, No Snubber)	(dl/dt)c	1.75	-	-	A/ms
Critical Rate of Rise of On–State Current ($T_J = 125$ °C, $f = 120$ Hz, $I_G = 2 \times I_{GT}$, tr ≤ 100 ns)	dl/dt	_	_	45	A/µs
Critical Rate of Rise of Off-State Voltage $(V_D = 0.66 \times V_{DRM'}, Exponential Waveform, Gate Open, T_J = 125°C)$	dV/dt	10	_	-	V/µs

Voltage Current Characteristic of SCR

Symbol	Parameter
V_{DRM}	Peak Repetitive Forward Off State Voltage
l _{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Reverse Off State Voltage
I _{RRM}	Peak Reverse Blocking Current
V_{TM}	Maximum On State Voltage
I.,	Holding Current

Quadrant Definitions for a Triac



All polarities are referenced to MT1.

With in—phase signals (using standard AC lines) quadrants I and III are used

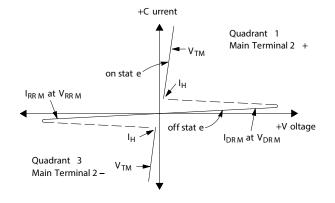


Figure 1. RMS Current Derating

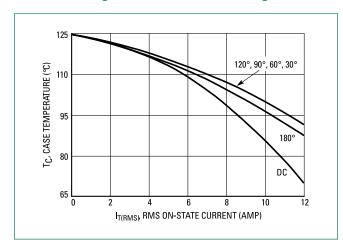


Figure 3. On-State Characteristics

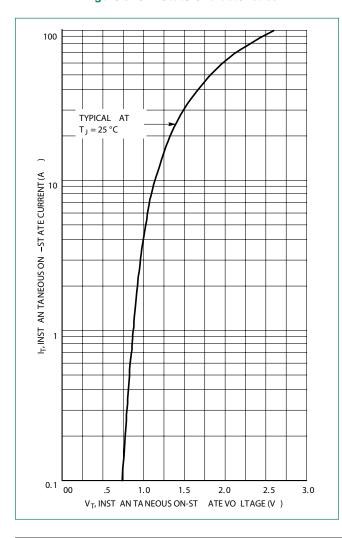


Figure 2. On-State Power Dissipation

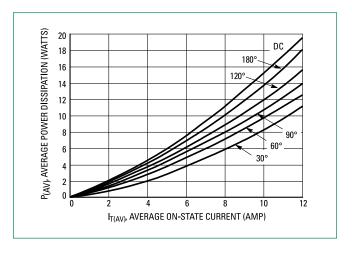


Figure 4. Thermal Response

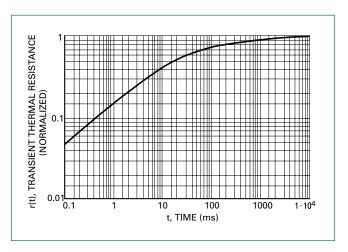


Figure 5. Typical Hold Current Variation

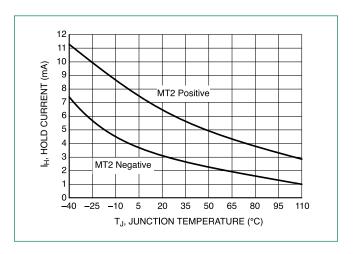




Figure 6. Typical Gate Trigger Current Variation

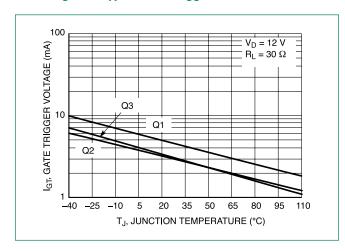


Figure 8. Typical Latching Current Variation

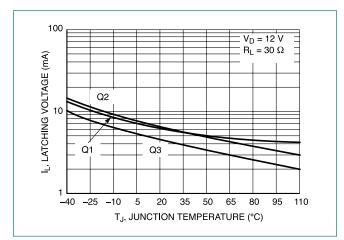


Figure 7. Typical Gate Trigger Voltage Variation

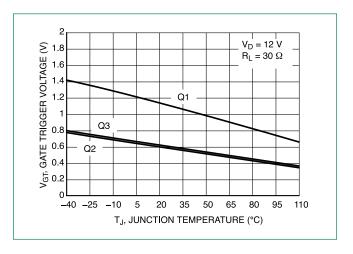


Figure 9. Critical Rate of Rise of Off-State Voltage (Exponential Waveform)

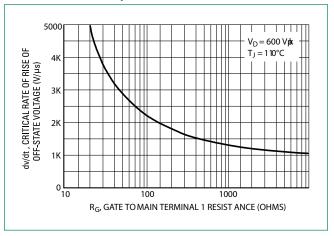
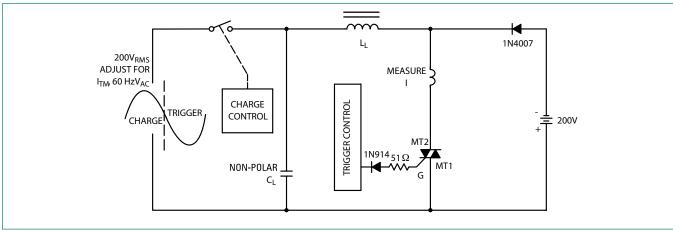


Figure 10. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)



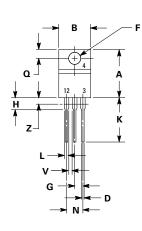
Note: Component values are for verification of rated (di/dt)c. See AN1048 for additional information

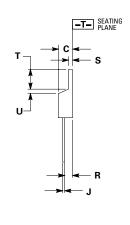


BTB12-600TW3G

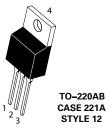
Surface Mount – 600V

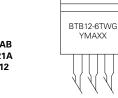
Dimensions





Part Marking System





x = 6 or 8 Y = Year M = Month A = Assembly Site XX = Lot Serial Code G = Pb-Free Package

D:	Inches		Millin	neters
Dim	Min	Max	Min	Max
Α	0.590	0.620	14.99	15.75
В	0.380	0.420	9.65	10.67
С	0.178	0.188	4.52	4.78
D	0.025	0.035	0.64	0.89
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.41	2.67
Н	0.110	0.130	2.79	3.30
J	0.018	0.024	0.46	0.61
K	0.540	0.575	13.72	14.61
L	0.060	0.075	1.52	1.91
N	0.195	0.205	4.95	5.21
Q	0.105	0.115	2.67	2.92
R	0.085	0.095	2.16	2.41
S	0.045	0.060	1.14	1.52
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
V	0.045	-	1.15	-
Z	-	0.080	-	2.04

Ordering Info
Device
BTB12-600TW3

riii Assigninent				
1	Main Terminal 1			
2	Main Terminal 2			
3	Gate			
4	No Connection			

Din Accianmon

ormation

Device	Package	Shipping
BTB12-600TW3G	TO-220AB (Pb-Free)	1000 Units / Box



^{1.} Dimensioning and tolerancing per ansi y14.5m, 1982.

Controlling dimension: inch.
 Dimension z defines a zone where all body and lead irregularities are allowed.